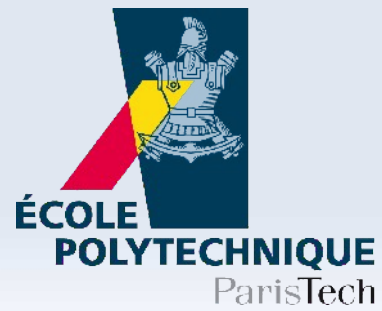


# Use of fine grained GRPC as $\pi$ & $\mu$ detectors for heavy ion target exp.

Vincent Boudry  
*LLR, École polytechnique*

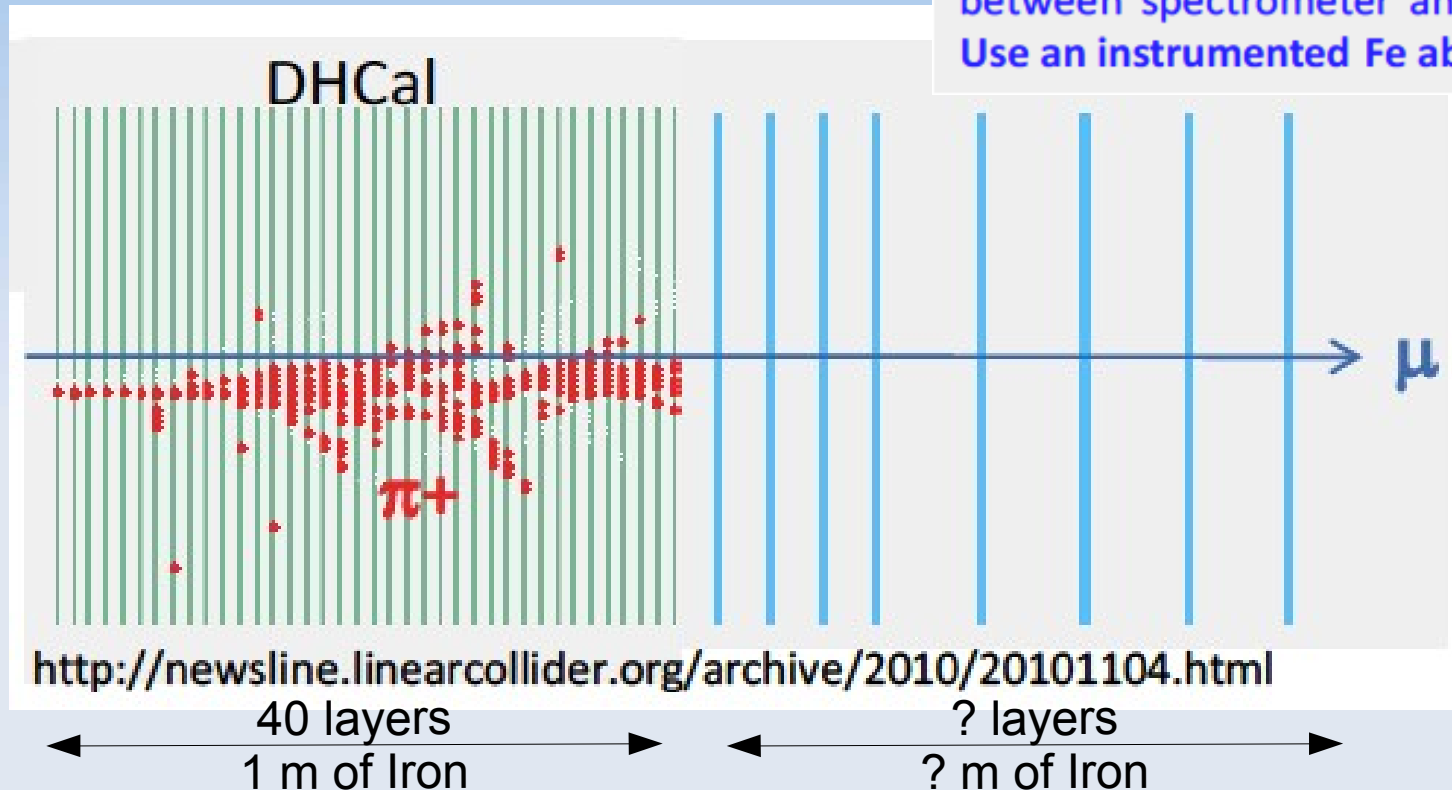


***Fixed target for heavy ions at cern  
IPNO Workshop  
07/07/2011***



# Questions

Need to match muon track position  
between spectrometer and trigger :  
Use an instrumented Fe absorber



- Use of Gas detectors
  - ▶ fine for  $\mu$ , OK for SHDCAL (rates ?)
- Optimal transverse granularity in  $\mu$  tracker
- Optimal longitudinal sampling in  $\mu$  tracker
- Triggering

## Highly Granular GRPC Semi-Digital HCAL

### Particle Flow Based

- $1 \times 1 \text{ cm}^2 \times 48$  layers
- Imaging calorimetry
  - Tracking in calorimeter
- Energy loss recovery

### Gaseous calorimetry

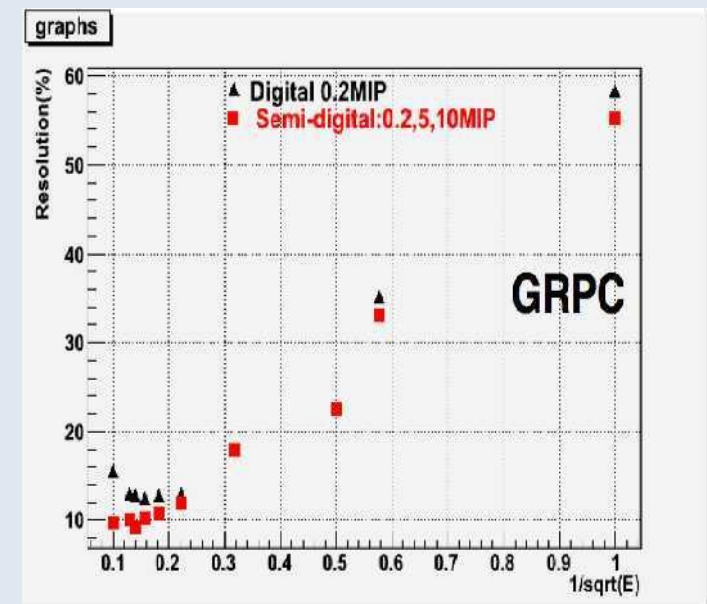
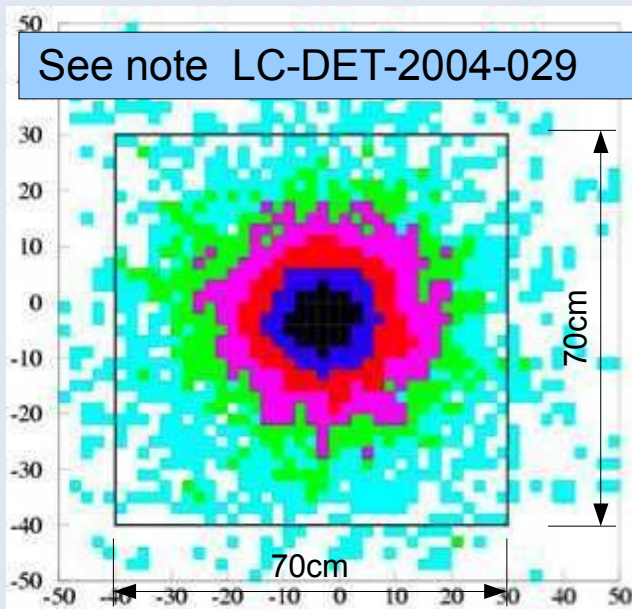
- Lower sensitivity to  $n$ 
  - Narrow showers (99% of 100 GeV  $\pi$  in  $70 \times 70 \text{ cm}^2$ )
- Less fluctuations (wrt H containing con

### 2 bits per cell

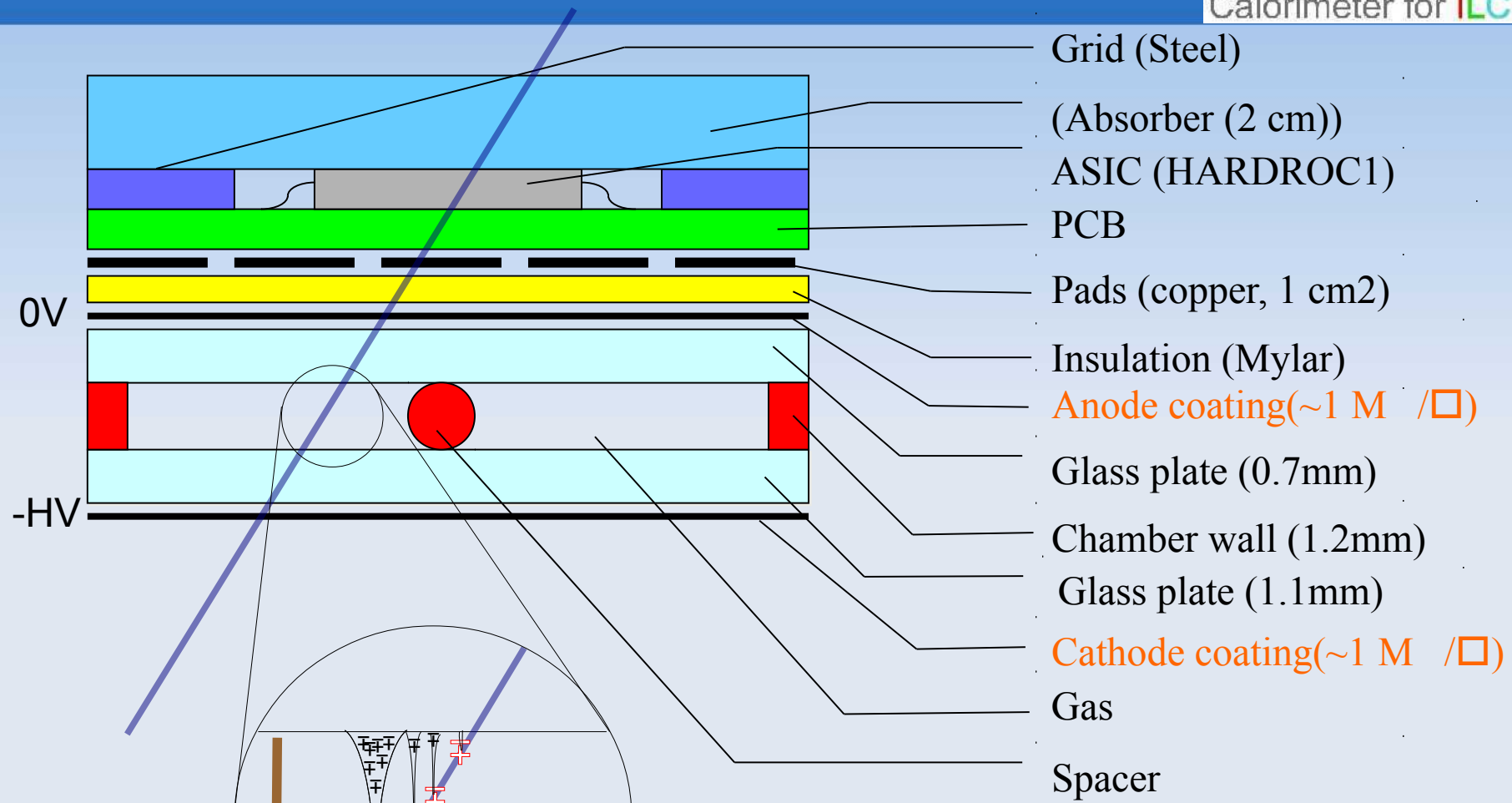
- Simplified electronics
  - reduced cost
  - less heat
- Improvement of energy rec. at High E.

### GRPC's

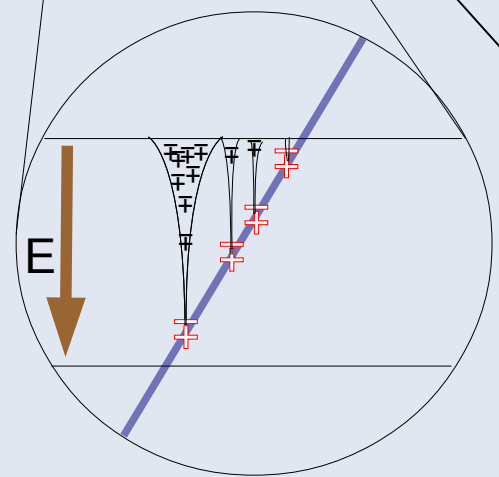
- Cheap
- Simple
- Reliable
- Large uniform surface (calibration of 70M ch.)



# Glass Resistive Plate Chamber



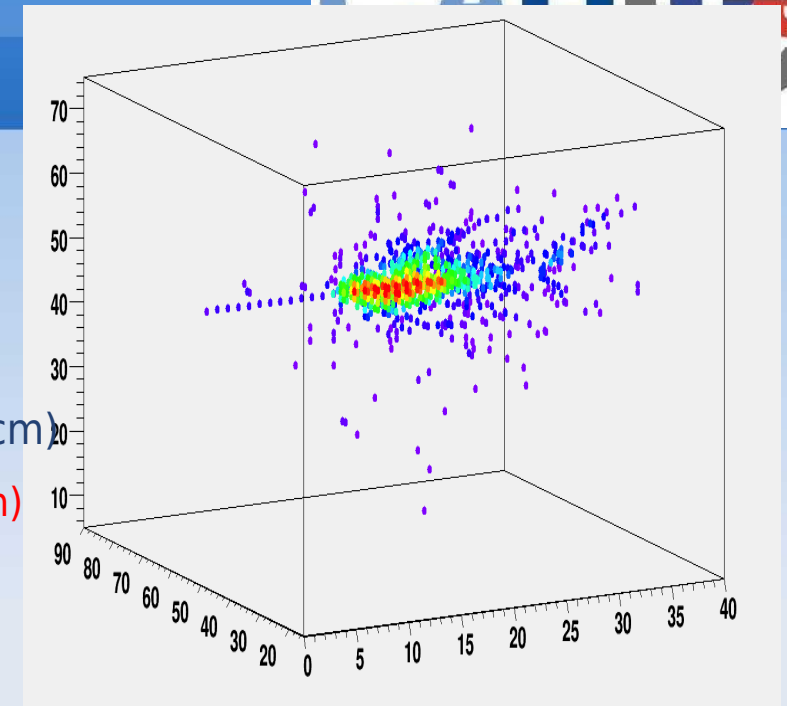
0V  
 -HV



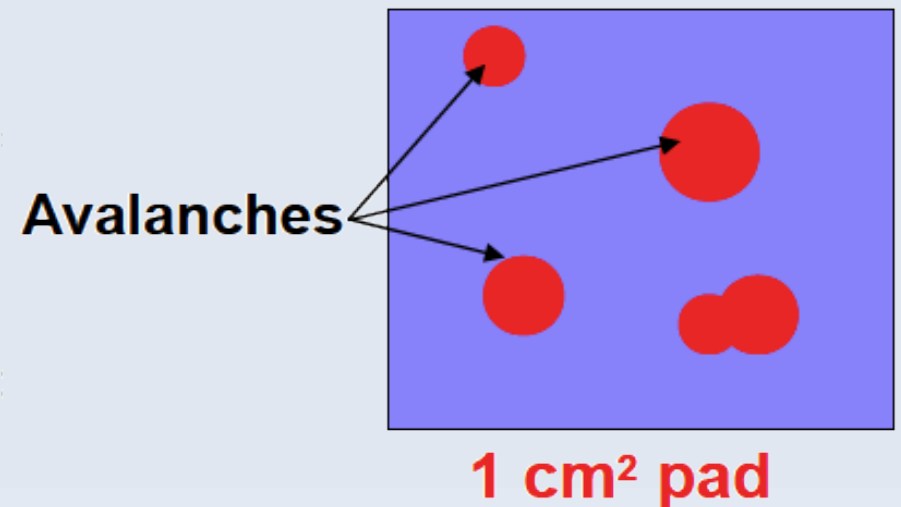
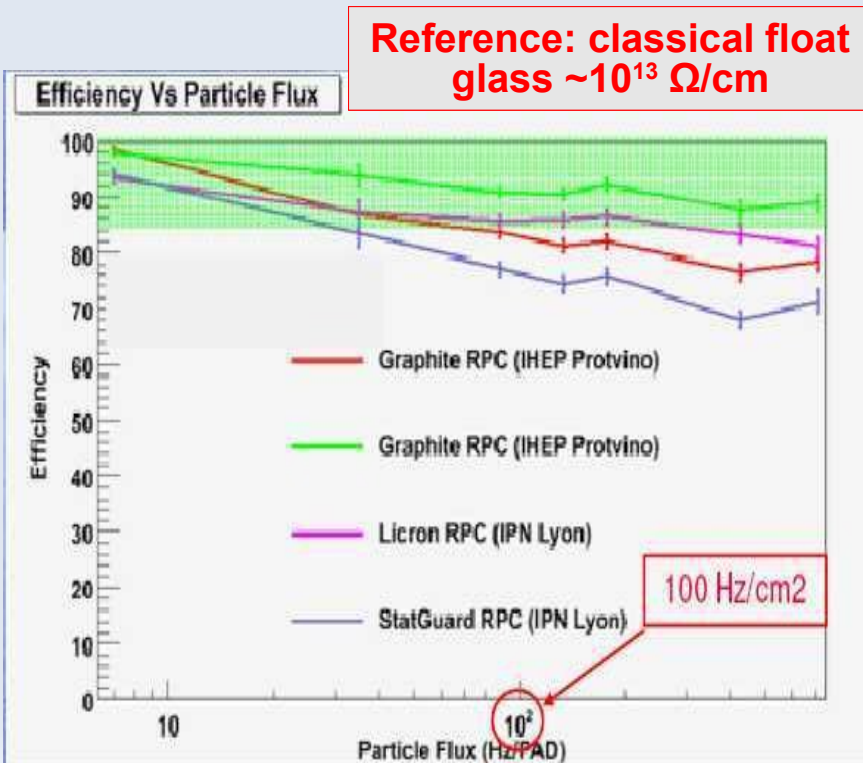
**Avalanche mode:**  
 Typical induced charge of  
 0.1—10 pC/mip with rising time ~10 ns  
 Very high timing precision :  
 1-2ns (standard) → 50ps (Multigap RPCs)

# Space & time

- Avalanches typical size ~ few mm<sup>2</sup>
- ~95-97% efficiency to mip
- Multiplicity ↗ 1.5 at cell boundary
- Rate limitatio1 ~ 100 Hz/cm<sup>2</sup> with standard Glass (10<sup>13</sup>Ω/cm)
  - ▶ OK @ ≥30 kHz/cm<sup>2</sup> with low resistivity glass (~10<sup>10</sup> Ω/cm)
  - ▶ Alternatives: μMegas or GEMs (in early phase & more expensive)

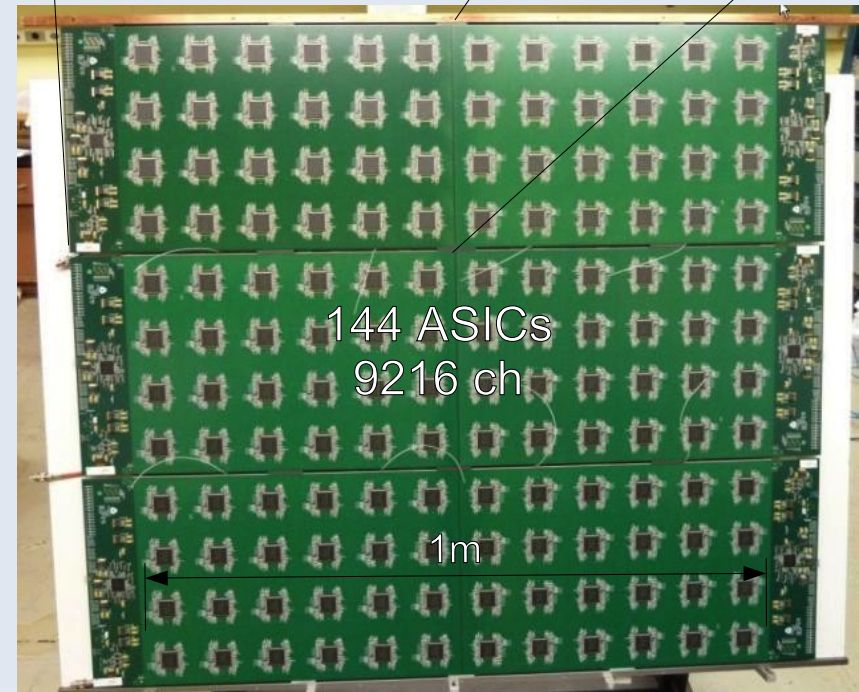
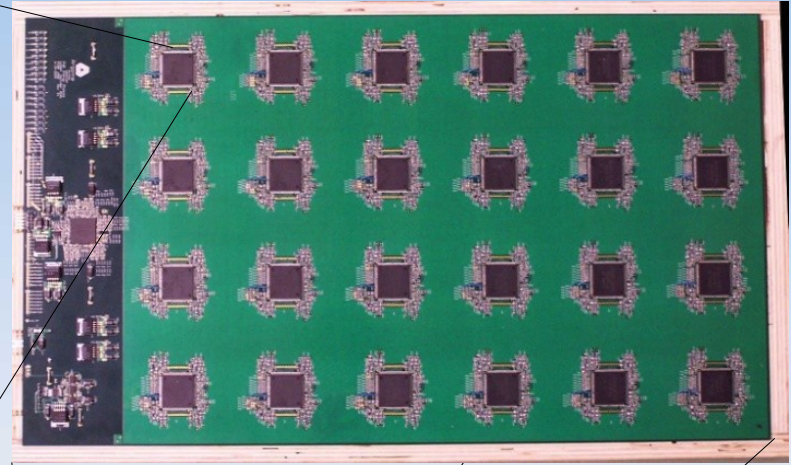
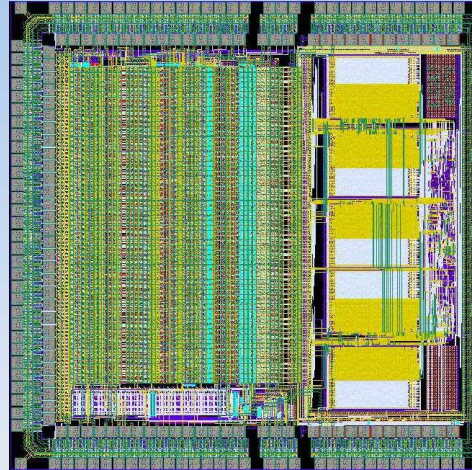


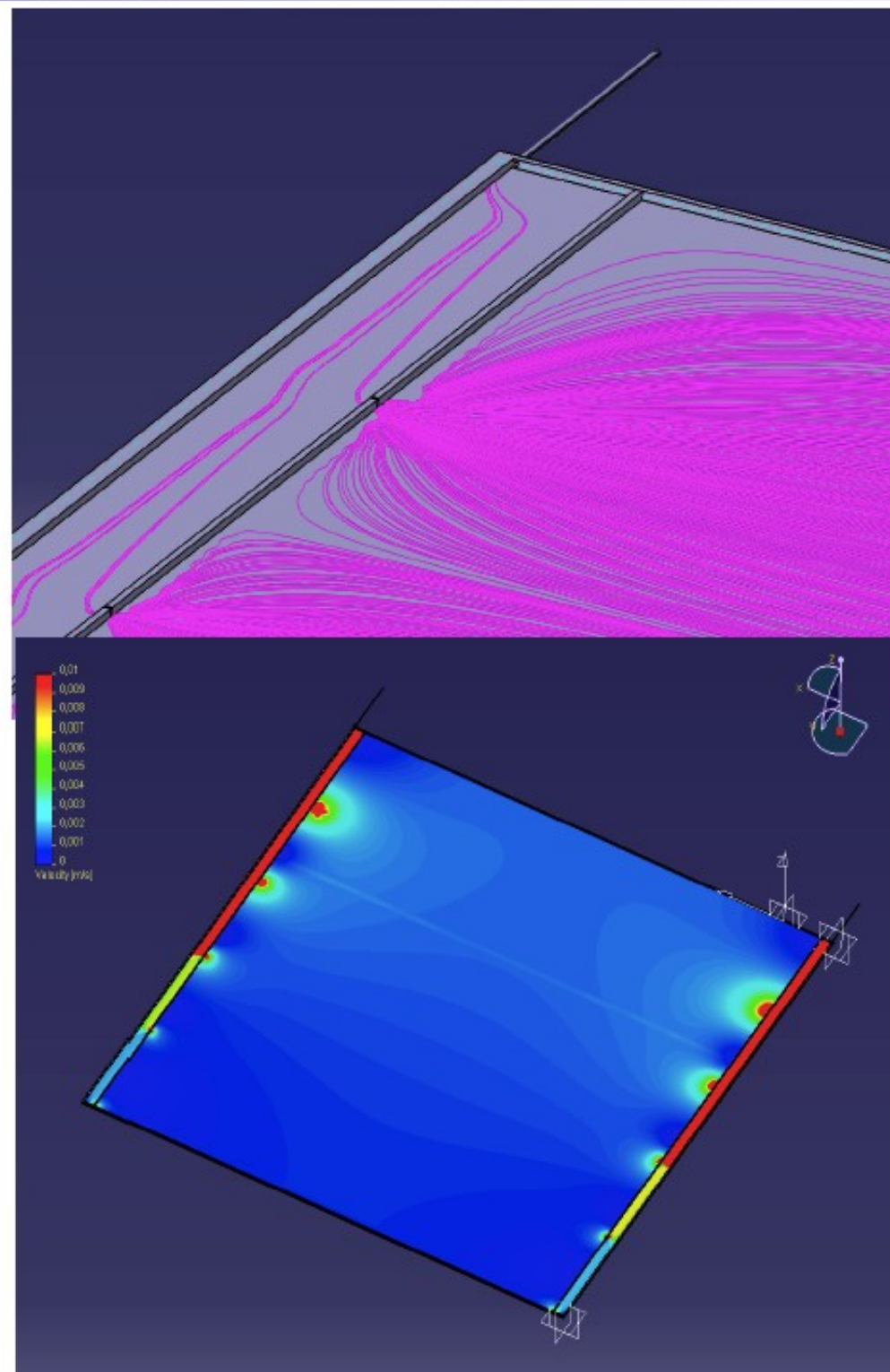
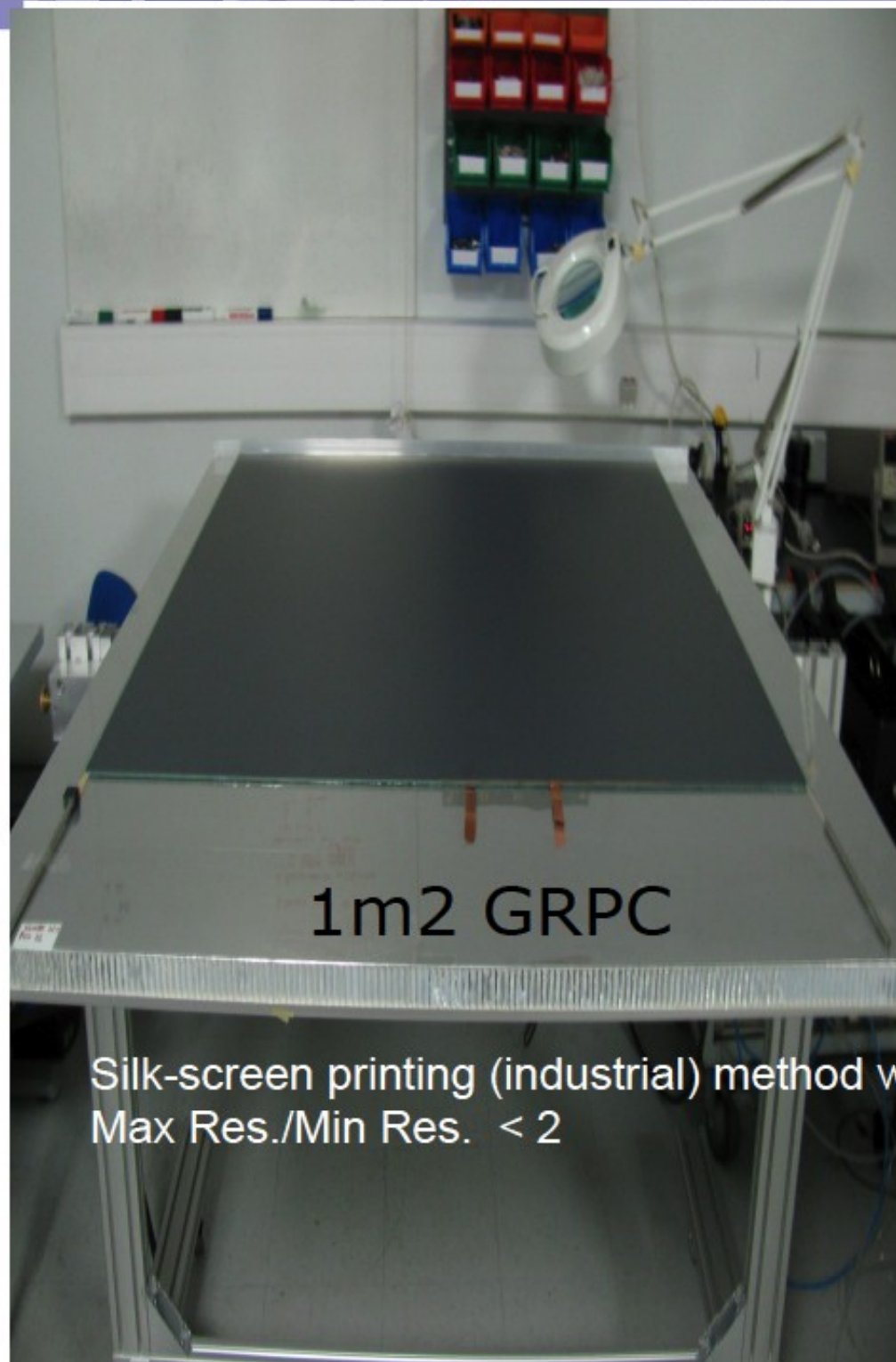
Simulation of a 100 GeV  $\pi$



# Readout electronics

- **HARDROCv2**  
from LAL-Omega
  - ▶ 64 ch readout chips
    - ◆ indep Gains
  - ▶ 3 indep thresholds
  - ▶ Auto-triggering
    - ◆ Zero suppr.
  - ▶ independent gains
  - ▶ power pulsing
    - ◆  $7\mu\text{W}/\text{ch}$  @ 0.5% duty cycle
  - ▶ 128 events memory
- Cost (for ILD , 72 Mch)
  - ▶ ASIC:  $\sim 0.12\text{€}$  / channel
  - ▶ PCB  $\sim 600\text{€}/\text{m}^2$



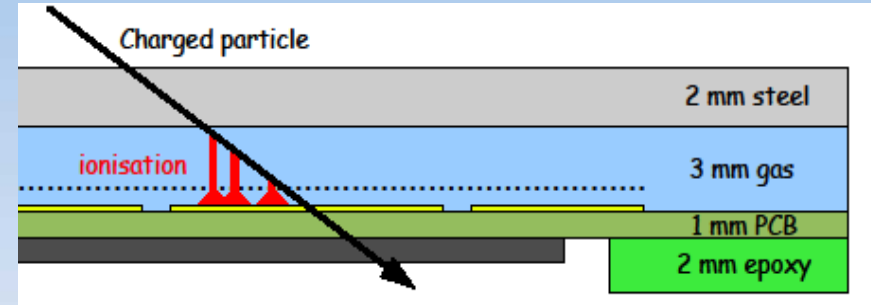


# Micro-Megas

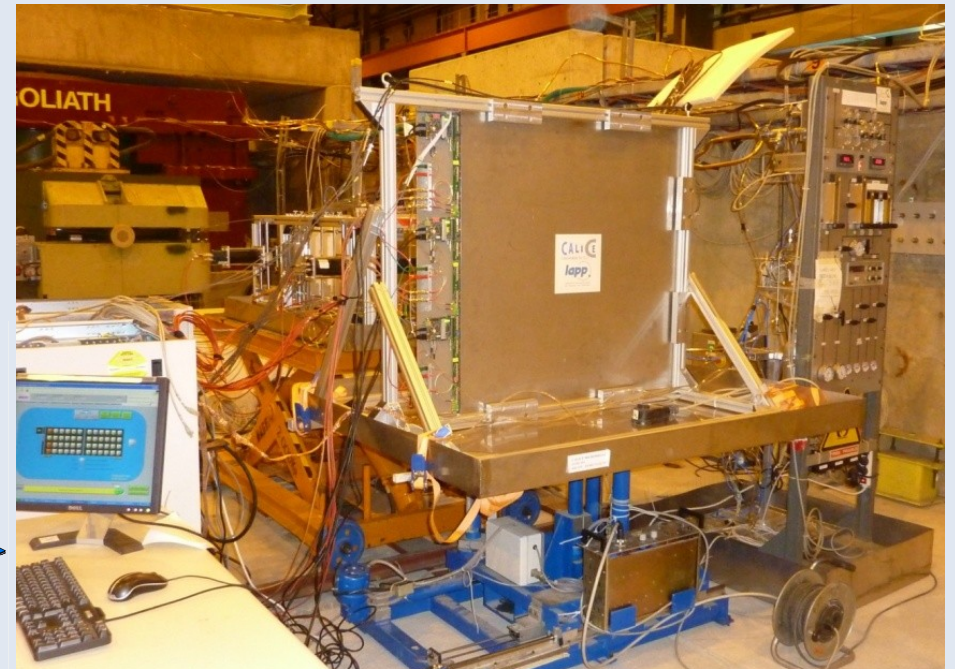
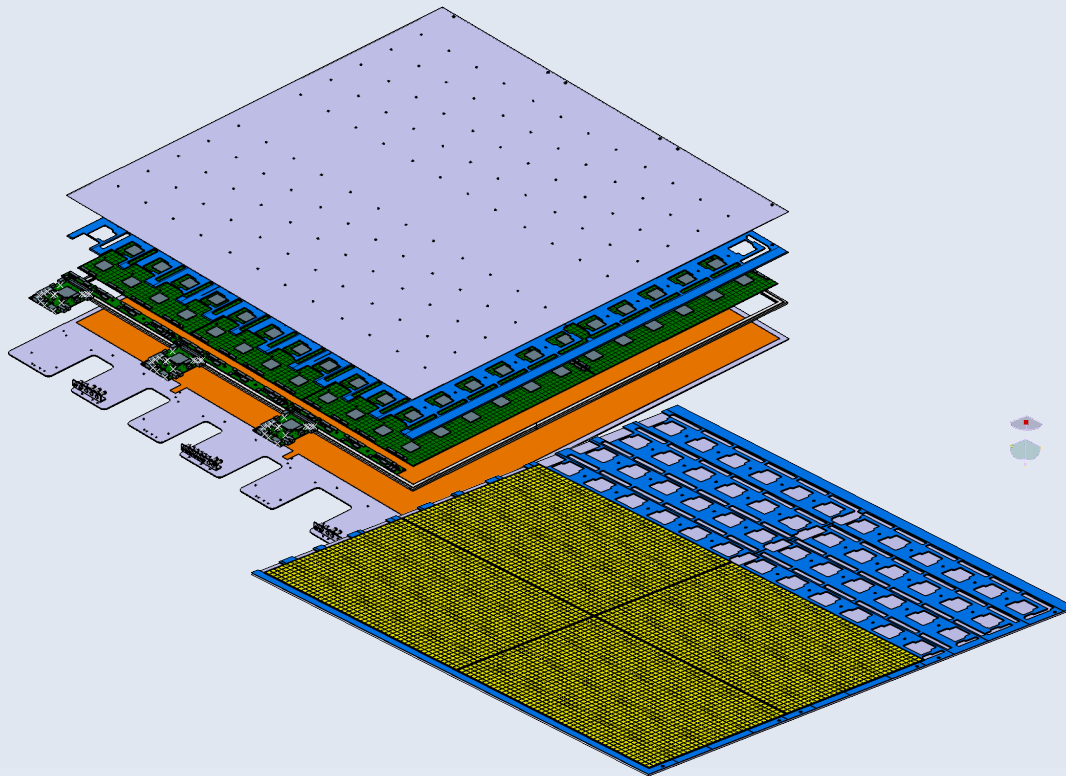
In earlier R&D phase than RPC  
(*more challenging: protection against sparking,  
smaller signals*) but progressing well...

No practical rate limitation ( $\sim 10^9 \text{ mm}^{-2} \text{ s}^{-1}$  !!)

Cost  $\sim 2000\text{€}/\text{m}^2$



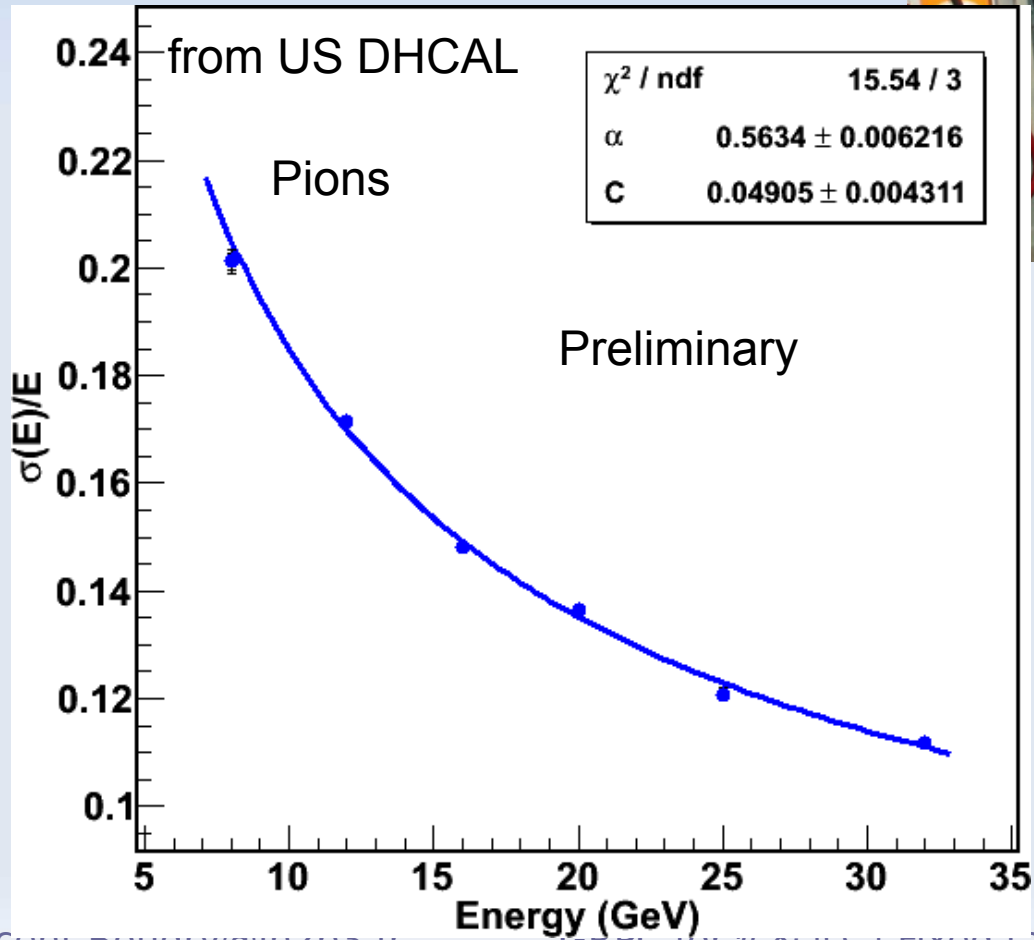
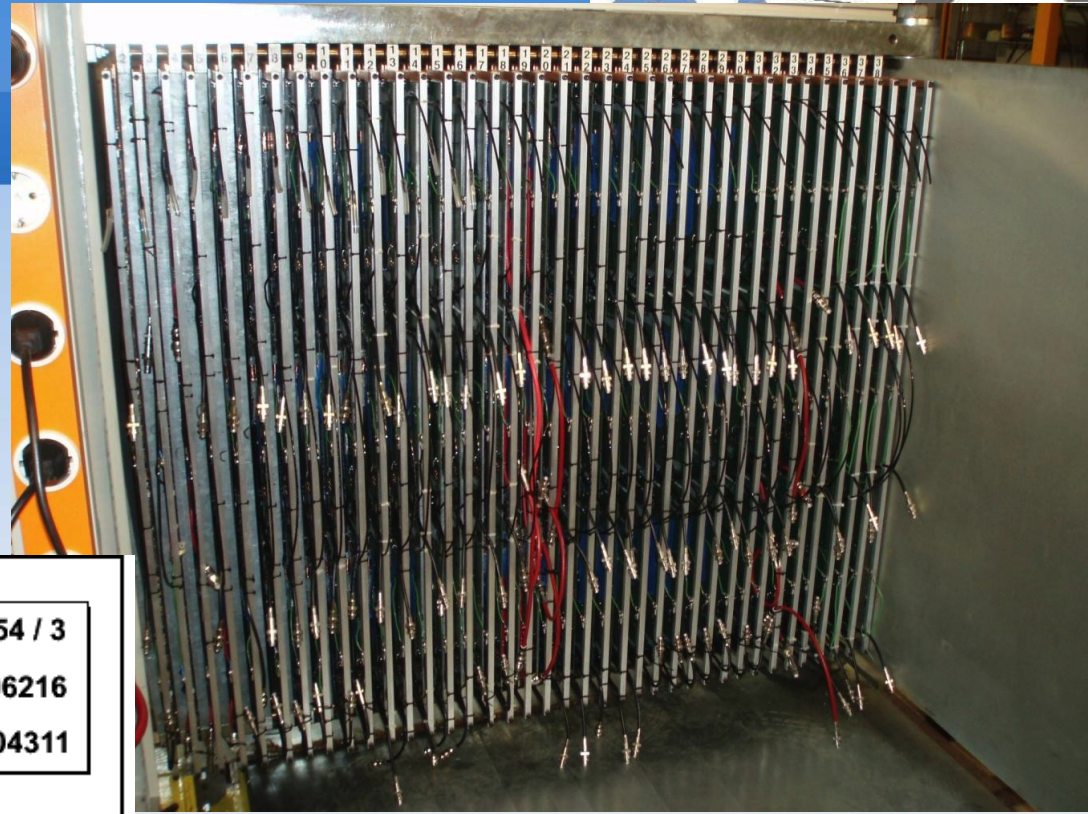
LAPP CALICE group





# RPC Prototypes

- $2 \times 1 \text{ m}^3$ 
  - ▶ Phys DHCAL (US) & techn. SDHCAL (FR)
  - ▶ 10000 ch /  $\text{m}^2$
  - ▶ 40 layers
  - ▶ 400000 channels



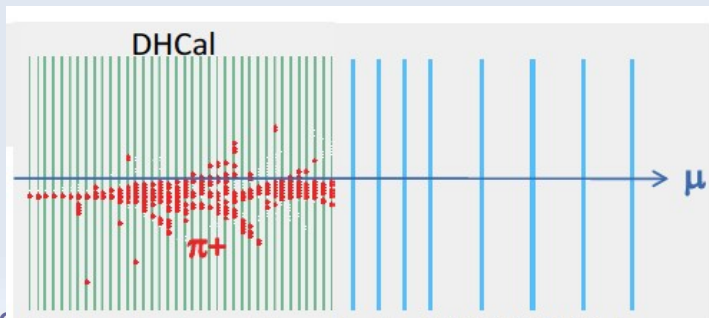
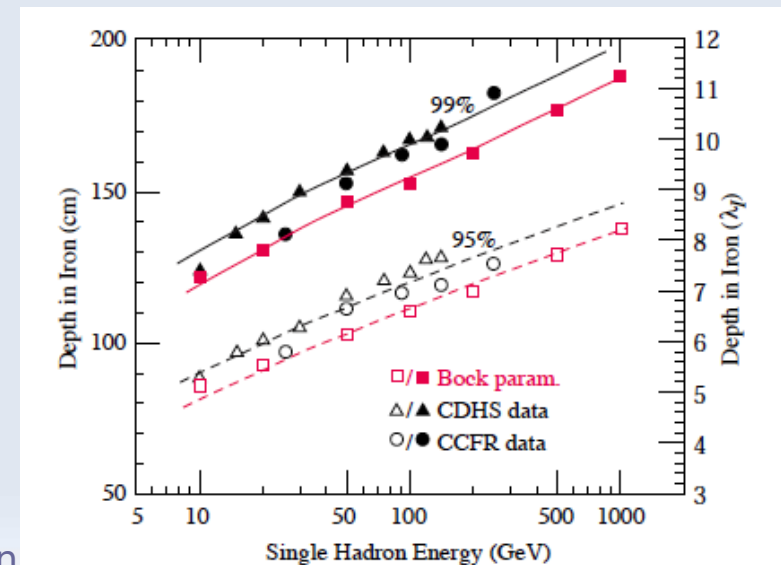
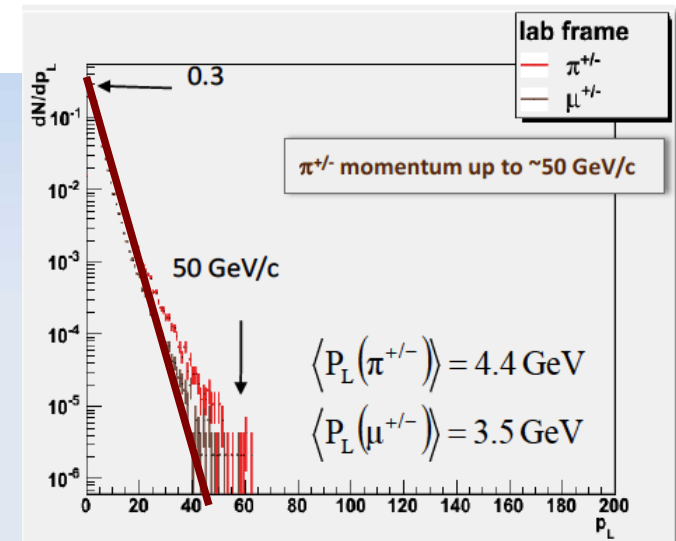
# Rates in HCAL

## Number of min bias events (for Pb+Pb)

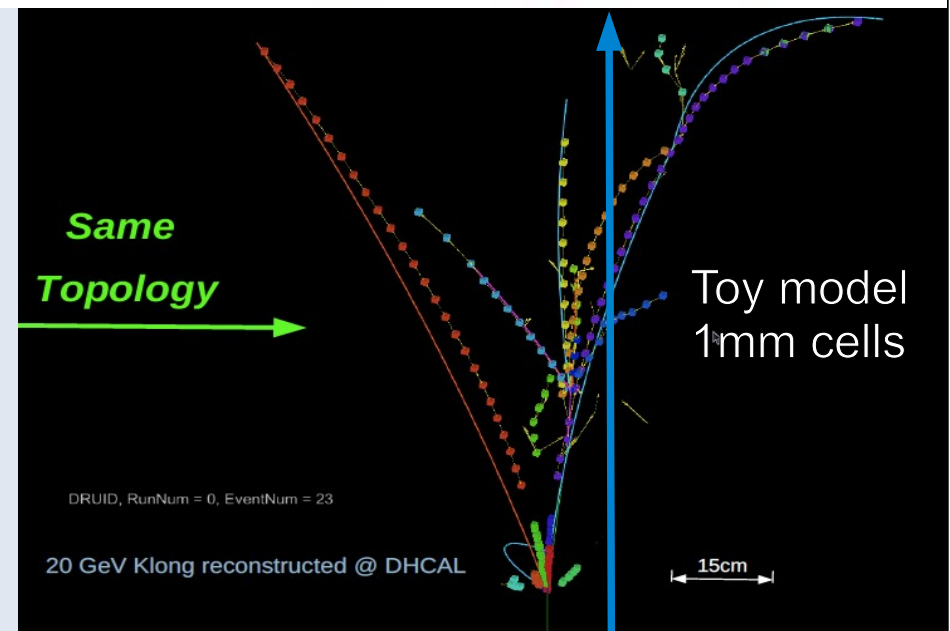
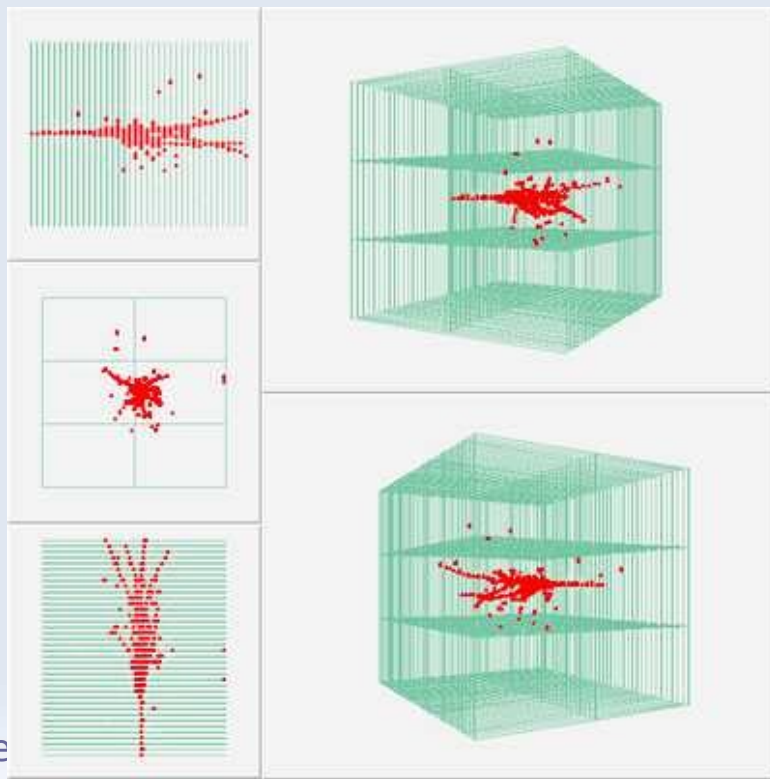
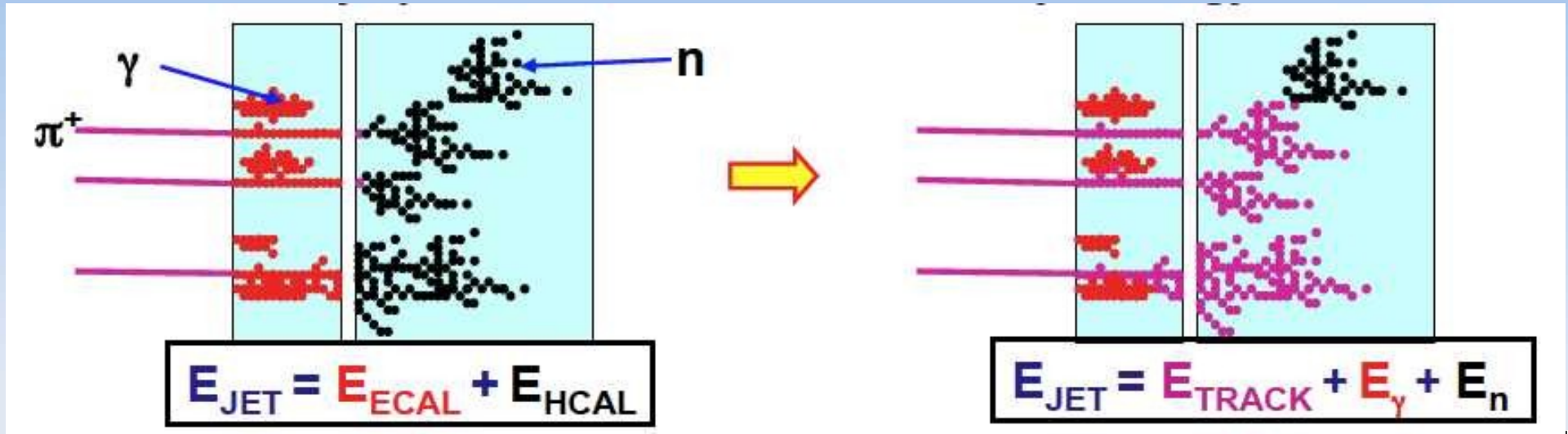
–  $\sigma_I = 68.8 \times (A^{1/3}_{proj} + B^{1/3}_{targ} - 1.32)^2 \rightarrow \sigma^{PbPb}_{minbias} = 68.8 \times (208^{1/3} + 207.19^{1/3} - 1.32)^2 = 7.62 \text{ barn}$

–  $N_{events/sec} \sim 0.3 \times 10^6 \times 7.62 \sim 2.3 \text{ MHz}$

- Average # of  $\pi = 0.3 \times 4.4 = 1,32 \pi / \text{evt} ???$
- $\sim 2.3 \text{ MHz} \times 1.32 = 3 \text{ MHz}$  of  $\pi$ 
  - ▶ contained in  $70 \times 70 \text{ cm}^2$ ; occupancy  $\leq 10\%$
- Acceptable rates  $\sim 100 \text{ kHz}$  (for semi conductive RPC):
  - ▶ 1/30 reduction rate  $\sim 1 \text{ m}$  of Iron
  - ▶  $\rightarrow$  first layers in  $\mu\text{Megas}$
- More realistic numbers on  $\pi$ 's needed...
- **Key feature: early layer to follow  $\mu$  tracks...**



# Calorimetry for PFA



Optimal granularity depends density of particle

# Muons Multiple scattering

$\psi_{\text{plane}}^{\text{RMS}}$  in rad

$$\theta_0 = \frac{13.6 \text{ MeV}}{\beta c p} z \sqrt{x/X_0} \left[ 1 + 0.038 \ln(x/X_0) \right]$$

m of Fe	0.2	0.5	1.0	2.0	3.0	5.0
$x/X_0$	11	28	57	114	171	285
$p_{\mu}$ {GeV}						
3.0	0.010	0.016	0.023	0.033		
$\sigma$ /cm	0.193	0.787	2.278	6.592		
7.0	0.004	0.007	0.010	0.014	0.018	0.023
$\sigma$ /cm	0.083	0.337	0.976	2.824	5.257	11.495
15.0	0.002	0.003	0.005	0.007	0.008	0.011
$\sigma$ /cm	0.039	0.157	0.456	1.318	2.453	5.364

$\theta_0$  = fit of a Gaussian distribution on

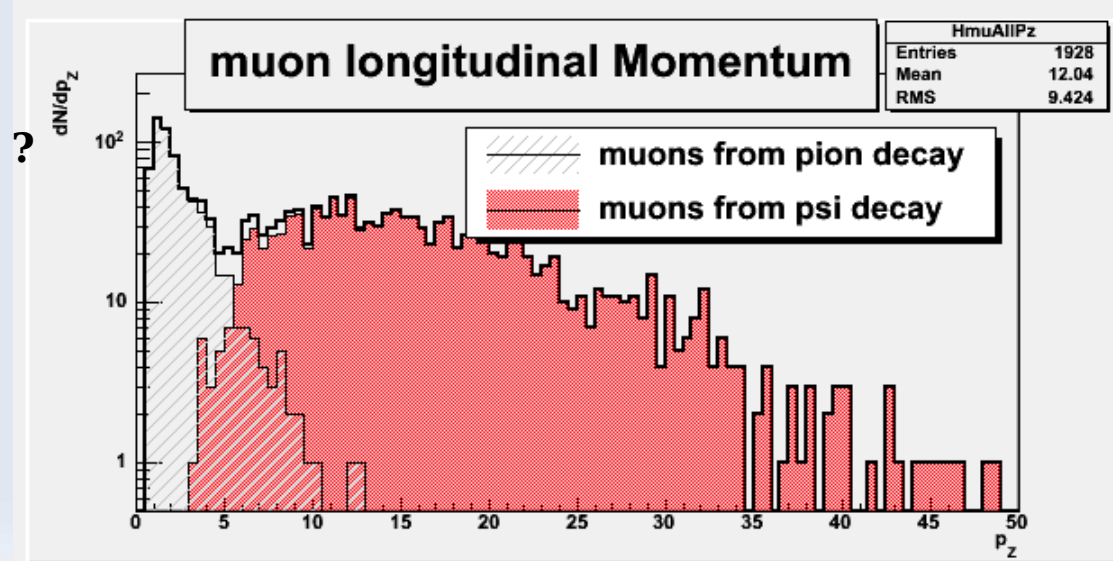
$$\text{RMS}_{\text{plane}} = 1/\sqrt{2} \text{RMS}_{\text{space}}$$

precision  $\leq 11\%$  for  $0.001 < x/X_0 < 100$

$\psi$  = planar angle of opening at the exit  $\sim 1/\sqrt{3} \theta_0$

- 7 GeV ( $\sim$ lowest  $J/\psi$   $\mu$ 's)  $\mu$  will scatter over
- 0.3 cm for 0.5m of Fe  $\leftarrow$  **proper interlayer ?**
  - 1 cm for 1m
  - 3 cm for 2m
  - 5 cm for 3m
  - 11 cm for 5m

Additional layers needed at beginning



## Detector – trigger rate in Pb+Pb

- Pb Beam intensity**

- NA50  $\rightarrow$   $5 \cdot 10^7$  ions/bunch  $\rightarrow$   $10^7$  ions/sec (with a bunch time length  $\sim$  5 sec)
- **Luminosity** :  $\mathcal{L} = N_b \times N_T = N_b \times (\rho \times e \times \mathcal{N}_A) / A = 10^7 \times (11.35 \times 1 \times 6.02 \cdot 10^{23}) / 207.19 = 0.3 \mu\text{b}^{-1}\text{s}^{-1}$

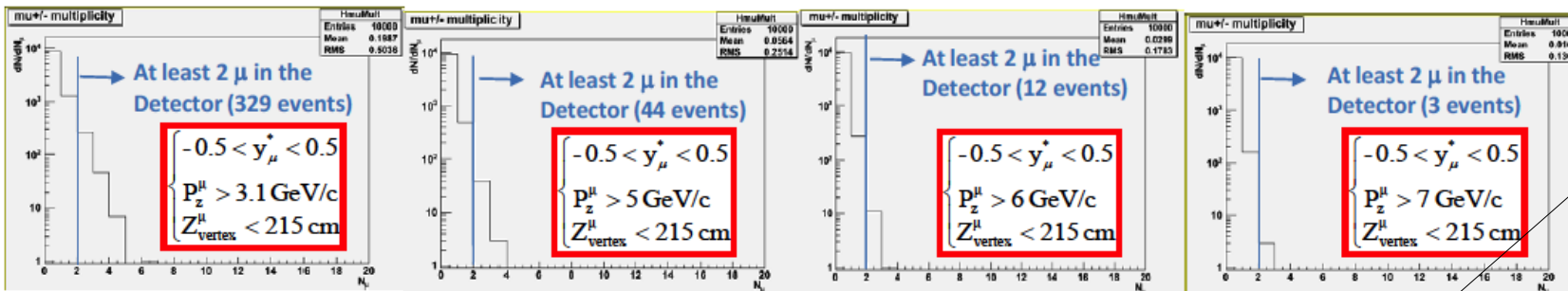
- Number of min bias events (for Pb+Pb)**

- $\sigma_I = 68.8 \times (A^{1/3}_{\text{proj}} + B^{1/3}_{\text{targ}} - 1.32)^2 \rightarrow \sigma^{\text{PbPb}}_{\text{minbias}} = 68.8 \times (208^{1/3} + 207.19^{1/3} - 1.32)^2 = 7.62 \text{ barn}$
- **Nevents/sec**  $\sim 0.3 \cdot 10^6 \times 7.62 \sim 2.3 \text{ MHz}$

- Event rejection :**

10 000 Pb+Pb minbias events generated with EPOS 1.6

Absorber starts @ 205 cm  
 $\pi^\pm$  stop decaying after  $1 \lambda_i$  in tungsten ( $\lambda_i \sim 10\text{cm}$ )  
 $\rightarrow \pi^\pm$  stop decaying @ 2.15 m

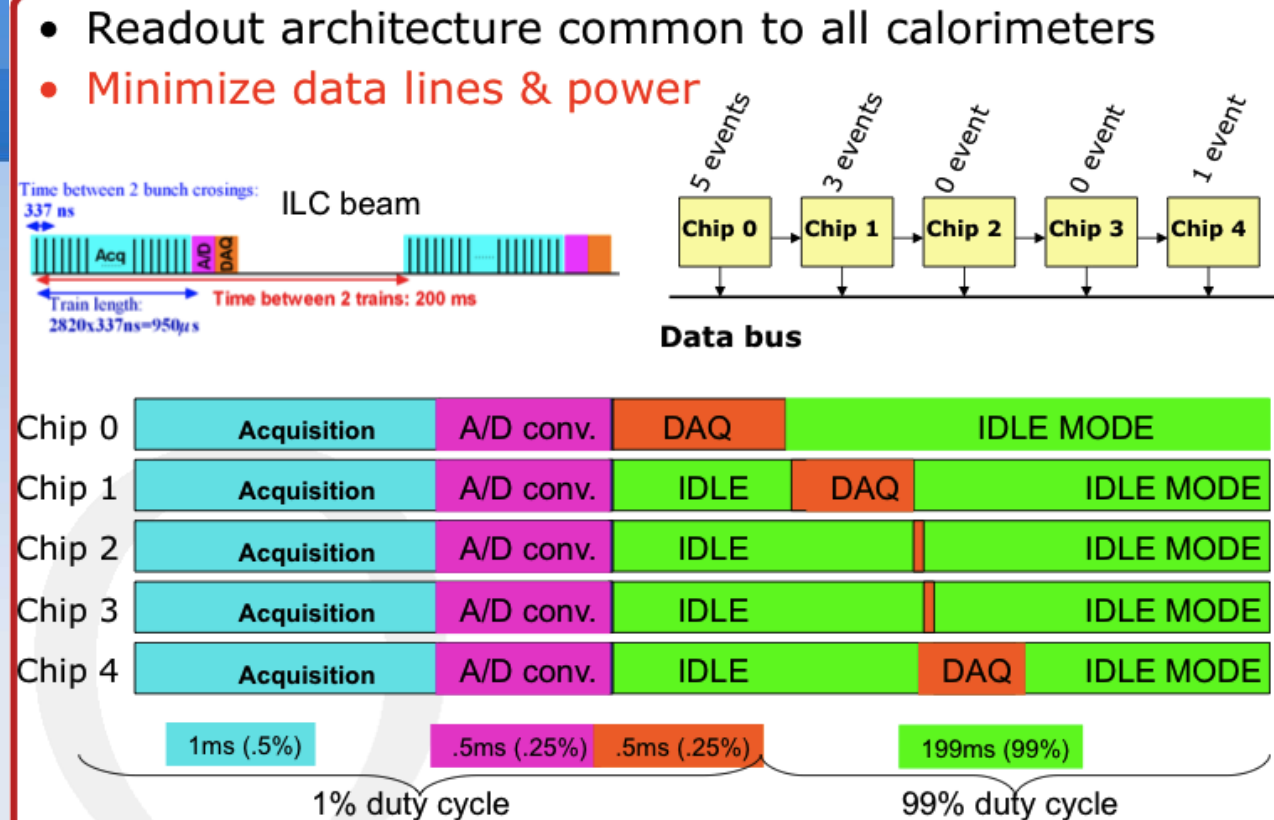


Fine with RPC ( $\ll 100 \text{ Hz} / \text{cm}^2$ )

3.2m Fe abs.:  $P_z > 5 \text{ GeV}/c$ : Trigger accepts 44/10000 events  $\rightarrow N_{\text{events}}/\text{sec} \sim 2.3 \text{ MHz} \times 4.4 \cdot 10^{-3} \sim 10 \text{ kHz}$   
 3.8m Fe abs.:  $P_z > 6 \text{ GeV}/c$ : Trigger accepts 12/10000 events  $\rightarrow N_{\text{events}}/\text{sec} \sim 2.3 \text{ MHz} \times 1.2 \cdot 10^{-3} \sim 2.8 \text{ kHz}$   
 4.5m Fe abs.:  $P_z > 7 \text{ GeV}/c$ : Trigger accepts 3/10000 events  $\rightarrow N_{\text{events}}/\text{sec} \sim 2.3 \text{ MHz} \times 3 \cdot 10^{-4} \sim 700 \text{ Hz}$

### ILC

- Embedded electronics
  - cooling
  - power pulsing  
DC = 0.5%
- Triggerless
- Built-in memory



### Fixed Target

- Embedded electronics ECAL & HCAL & inner muons
  - cooling
  - power pulsing : DC ~ 10%
- Triggered → implement a circular buffer for built-in memory
- Slight modifications needed
- Embedded electronics outer Muons
  - cooling
  - power pulsing : DC ~ 10%
- Continuous readout for trigger on auto-trigger
- a priori : No modification needed

# Costs scaling laws

- From ILD Letter of Intend

- ▶ Electronics

- ◆ ASIC:  $\sim 0.12\text{€} / \text{channel}$

- ◆ PCB  $\sim 600\text{€}/\text{m}^2$

- ▶ Sensors:

- ◆ RPC :  $\sim 200 \text{€} / \text{m}^2$

- ◆  $\mu\text{Megas} \sim 2000\text{€}/\text{m}^2 \rightarrow \text{early layers ?}$

- ▶ Iron:

- ◆  $\sim 120\text{k€}/\text{m}^3$

- 1 DHCAL (without Fe)

- ▶  $\text{Ø } 60 \text{ cm} \times 30 \text{ layers} \rightarrow 33 \text{ m}^2$

- ▶  $1 \text{ cm}^2 \text{ cells} \rightarrow 33000 \times 0.12 + 33 \times 600 + 200 \times 33 = 30\text{k€}$  (89000 for  $\mu\text{Megas}$ )

- ▶  $5 \times 5 \text{ mm}^2 \text{ cells} \rightarrow 132000 \times 0.12 + 33 \times 600 + 200 \times 33 = \sim 42\text{k€}$  [cost = technology!]

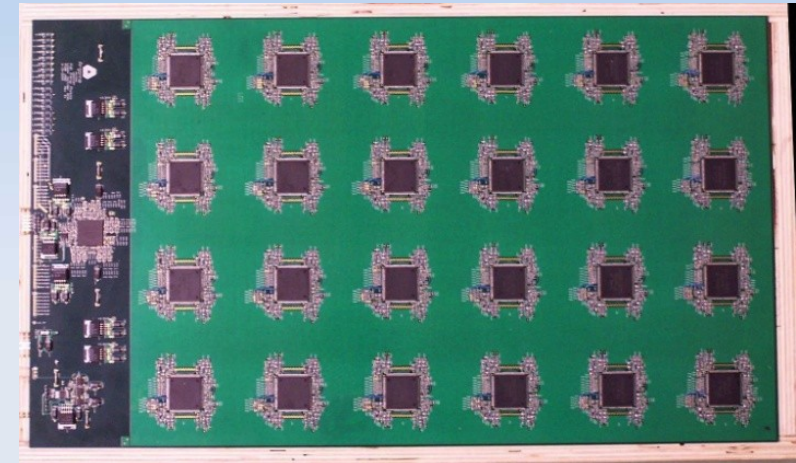
- instrumented Fe

- ▶  $\text{Ø } 100 \text{ cm} \times 10 \text{ layers} \rightarrow 31 \text{ m}^2$

- ▶ identical prices

+ 40k for DAQ

+ 40k for gas system



# Additional consideration

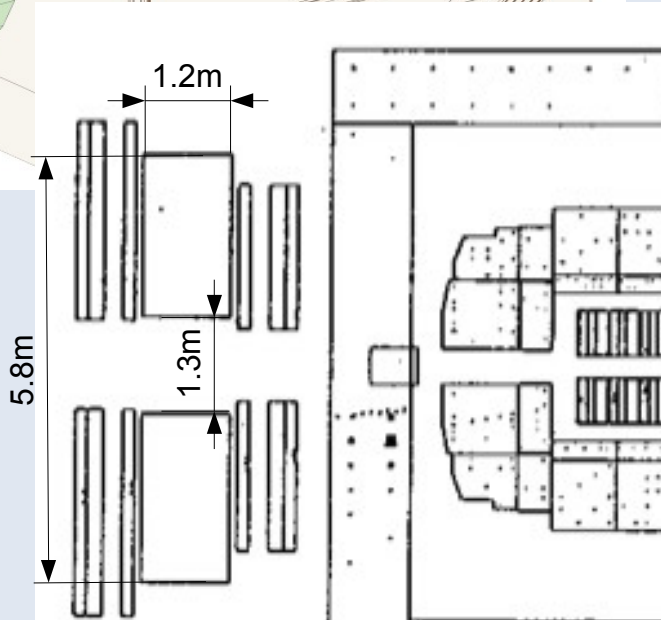
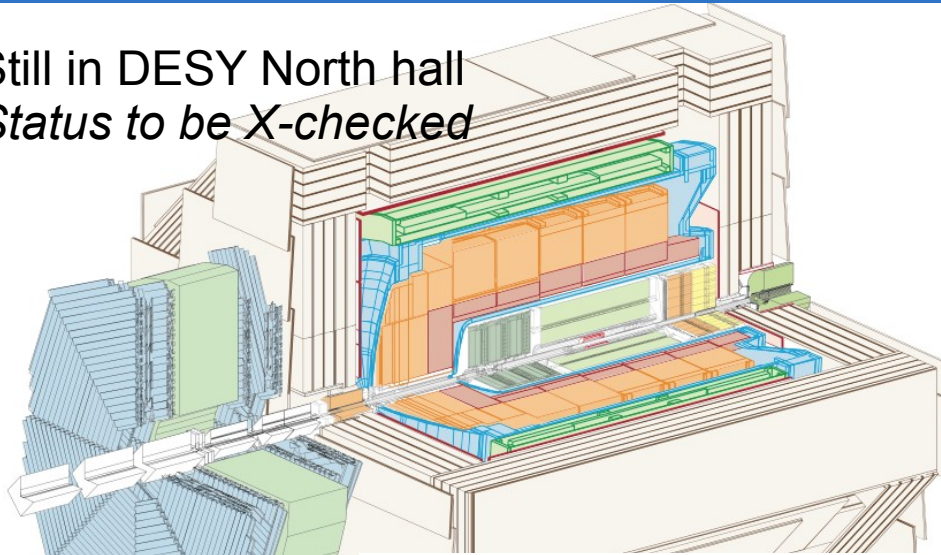


- Strips vs Pads
  - ▶ at low occupancy  $\rightarrow$  5mm  $\times$  10-30 cm strips ?
    - ◆ Electronics cost  $\propto$  (cell size)<sup>2</sup>
- Magnetic field  $\rightarrow$  H1 Toroid ?
- Triggering to be reviewed wrt to ILC electronics
  - ▶  $\rightarrow$  Circular buffering in chips
  - ▶ 1 threshold
- Streamer mode vs avalanche mode
  - ▶ streamer  $\rightarrow$  higher signal  $\rightarrow$  simplified electronics  $\rightarrow$  costs  $\searrow$ 
    - ◆ for ex : kPix chips (1024 channels) from FNAL/Argonne

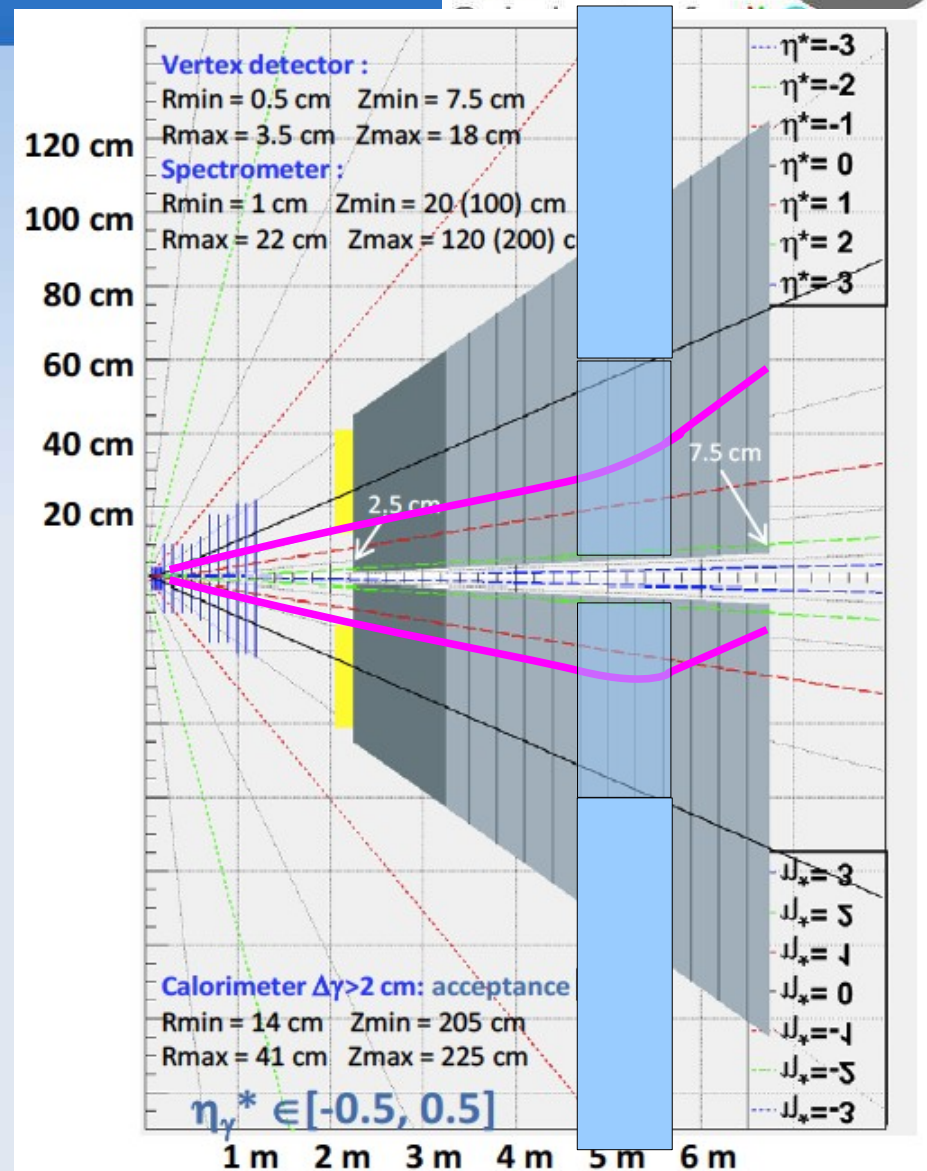


# H1 toroid magnet

Still in DESY North hall  
 Status to be X-checked



@ 150A  $B=1.75 \rightarrow 1.5$  T



→ Would need completion or complete re-design

- Gas digital calorimetry is optimal for hadronic pattern shower reconstruction
  - ▶ insensitivity to neutrons, very high granularity possible.
- Gas sensors for DHCAL and DMuons
  - ▶ GRPC are cheap and reliables but limited in rate
  - ▶  $\mu$ Megas are more expensive and require care but unlimited in rate
    - ◆ Combine both for reasonable cost
- Density of sensor layer & granularity require some optimisation wrt **density of particle**
  - ▶ identification & tracking of muons
  - ▶  $1 \times 1 \text{cm}^2$  done and almost immediately usable
    - ◆  $\times 4$  in granularity achievable: perf to be evaluated.
- CALICE electronics needs only small adaptations